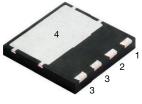
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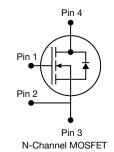


E Series Power MOSFET

PRODUCT SUMMARY					
V _{DS} (V) at T _J max.	700				
R _{DS(on)} typ. (Ω) at 25 °C	$V_{GS} = 10 V$	0.148			
Q _g max. (nC)	99				
Q _{gs} (nC)	16				
Q _{gd} (nC)	28				
Configuration	Single				

PowerPAK[®] 8 x 8





FEATURES

- Completely lead (Pb)-free device
- Low figure-of-merit (FOM) Ron x Qg
- Low input capacitance (Ciss)
- Reduced switching and conduction losses
- Ultra low gate charge (Qg)
- Avalanche energy rated (UIS)
- Kelvin connection for reduced gate noise
- Material categorization: for definitions of compliance please see <u>www.vishay.com/doc?99912</u>

APPLICATIONS

- · Server and telecom power supplies
- Switch mode power supplies (SMPS)
- Power factor correction power supplies (PFC)
- Lighting
 - High-intensity discharge (HID)
 - Fluorescent ballast lighting
- Industrial
 - Welding
 - Induction heating
 - Motor drives
 - Battery chargers
 - Renewable energy
 - Solar (PV inverters)

ORDERING INFORMATION	
Package	PowerPAK 8 x 8
Lead (Pb)-free and Halogen-free	SiHH21N65E-T1-GE3

ABSOLUTE MAXIMUM RATINGS ($T_C = 25 \degree C$, unless otherwise noted)						
PARAMETER	SYMBOL	LIMIT	UNIT			
Drain-Source Voltage		V _{DS}	650	V		
Gate-Source Voltage	V _{GS}	± 30	V			
Continuous Drain Current (T, = 150 °C)	$V_{GS} \text{ at } 10 \text{ V} \qquad \frac{T_{C} = 25 \text{ °C}}{T_{C} = 100 \text{ °C}}$		20.3			
Continuous Drain Current $(I_J = 150 \text{ C})$	$T_{\rm C} = 100 ^{\circ}{\rm C}$	ID	12.8	А		
Pulsed Drain Current ^a	I _{DM}	53	L .			
Linear Derating Factor			1.47	W/°C		
Single Pulse Avalanche Energy ^b		E _{AS}	353	mJ		
Maximum Power Dissipation	PD	156	W			
Operating Junction and Storage Temperature Range		T _J , T _{stg}	-55 to +150	°C		
Drain-Source Voltage Slope	T _J = 125 °C	dV/dt	70	- V/ns		
Reverse Diode dV/dt °		uv/ut	17	v/ns		

Notes

a. Repetitive rating; pulse width limited by maximum junction temperature.

b. V_{DD} = 140 V, starting T_J = 25 °C, L = 28.2 mH, R_g = 25 Ω , I_{AS} = 5 A.

c. $I_{SD} \leq I_D,\, dI/dt$ = 100 A/µs, starting T_J = 25 °C.

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THERMAL RESISTANCE RATI	NGS							
PARAMETER	SYMBOL	TYP.		MAX.		UNIT		
Maximum Junction-to-Ambient	R _{thJA}	39		51			°0 4 4	
Maximum Junction-to-Case (Drain)	R _{thJC}	0.51		0.68			°C/W	
SPECIFICATIONS ($T_J = 25 \ ^{\circ}C$, u	Inless otherwi	se noted)						
PARAMETER	SYMBOL		T CONDIT	IONS	MIN.	TYP.	MAX.	UNIT
Static							•	1
Drain-Source Breakdown Voltage	V _{DS}	V _{GS} =	= 0 V, I _D = 2	250 μA	650	-	-	V
V _{DS} Temperature Coefficient	$\Delta V_{DS}/T_{J}$	Referenc	e to 25 °C,	I _D = 1 mA	-	0.81	-	V/°C
Gate-Source Threshold Voltage (N)	V _{GS(th)}	V _{DS} =	· V _{GS} , I _D = 2	250 μA	2.0	-	4.0	V
			$V_{\rm GS} = \pm 20$		-	-	± 100	nA
Gate-Source Leakage	I _{GSS}		$V_{\rm GS} = \pm 30$	V	-	-	± 1	μA
		$V_{DS} = 650 \text{ V}, \text{ V}_{GS} = 0 \text{ V}$		-	-	1	r -	
Zero Gate Voltage Drain Current	I _{DSS}	V _{DS} = 520 V	, V _{GS} = 0 V	, T _J = 125 °C	-	-	25	μA
Drain-Source On-State Resistance	R _{DS(on)}	V _{GS} = 10 V		₀ = 11 A	-	0.148	0.170	Ω
Forward Transconductance	9 _{fs}	V _{DS}	= 30 V, I _D =	: 11 A	-	8.5	-	S
Dynamic		1 -				1		1
Input Capacitance	C _{iss}		V _{GS} = 0 V, V _{DS} = 100 V,		-	2404	-	-
Output Capacitance	C _{oss}	- -			-	102	-	
Reverse Transfer Capacitance	C _{rss}	f = 1 MHz		-	2	-		
Effective Output Capacitance, Energy Related ^a	C _{o(er)}	V_{DS} = 0 V to 520 V, V_{GS} = 0 V		-	75	-	pF	
Effective Output Capacitance, Time Related ^b	C _{o(tr)}			-	314	-		
Total Gate Charge	Qg				-	66	99	
Gate-Source Charge	Q _{gs}	V _{GS} = 10 V I _D = 11 A, V _{DS} = 520 V		-	16	-	nC	
Gate-Drain Charge	Q _{gd}				-	28	-	1 !
Turn-On Delay Time	t _{d(on)}				-	26	52	
Rise Time	t _r	V _{DD} =	= 520 V, I _D =	= 11 A,	-	46	92	1
Turn-Off Delay Time	t _{d(off)}		$V_{GS} = 10 \text{ V}, \text{ R}_{g} = 9.1 \Omega$		-	69	104	ns
Fall Time	t _f	- Č		-	44	88	1	
Gate Input Resistance	R _g	f = 1 MHz, open drain		0.27	0.55	1.10	Ω	
Drain-Source Body Diode Characteristi		•			·			
Continuous Source-Drain Diode Current	١ _S	MOSFET symbol showing the integral reverse p - n junction diode		-	-	20.3	•	
Pulsed Diode Forward Current	I _{SM}			-	-	53	A	
Diode Forward Voltage	V _{SD}	T _J = 25 °C, I _S = 11 A, V _{GS} = 0 V		-	0.9	1.2	V	
Reverse Recovery Time	t _{rr}				-	396	792	ns
Reverse Recovery Charge	Q _{rr}	$T_J = 25 \ ^{\circ}C, I_F = I_S = 11 \ A,$ dl/dt = 100 A/µs, V _R = 25 V		-	6.2	12.4	μC	
Reverse Recovery Current	I _{RRM}			-	26	-	Α	

Notes

a. $C_{oss(er)}$ is a fixed capacitance that gives the same energy as C_{oss} while V_{DS} is rising from 0 % to 80 % V_{DS} . b. $C_{oss(tr)}$ is a fixed capacitance that gives the same charging time as C_{oss} while V_{DS} is rising from 0 % to 80 % V_{DS} .



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TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

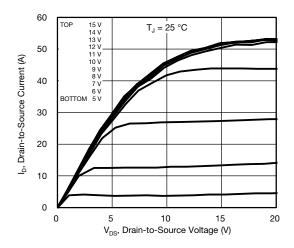
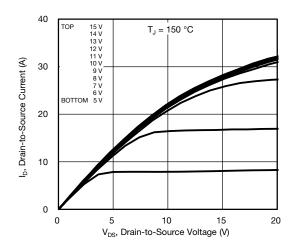
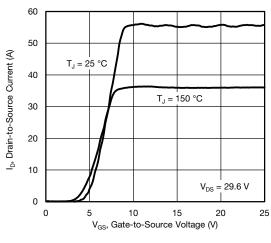


Fig. 1 - Typical Output Characteristics









3.0 0.5 0.5 0.6

Fig. 4 - Normalized On-Resistance vs. Temperature

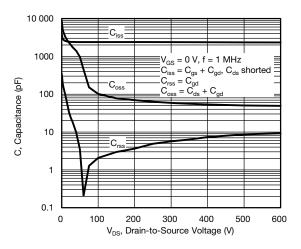


Fig. 5 - Typical Capacitance vs. Drain-to-Source Voltage

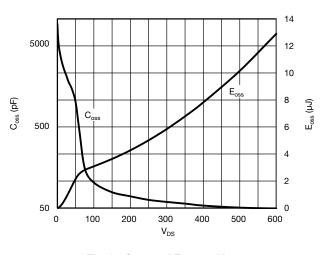


Fig. 6 - C_{OSS} and E_{OSS} vs. V_{DS}

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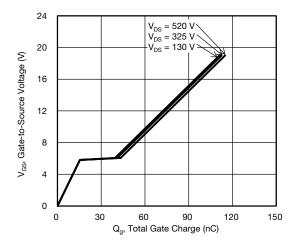


Fig. 7 - Typical Gate Charge vs. Gate-to-Source Voltage

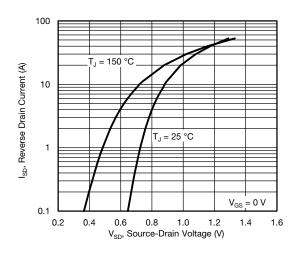


Fig. 8 - Typical Source-Drain Diode Forward Voltage

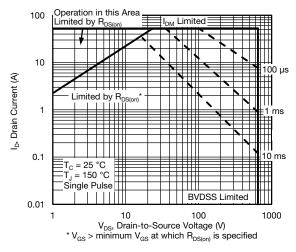


Fig. 9 - Maximum Safe Operating Area

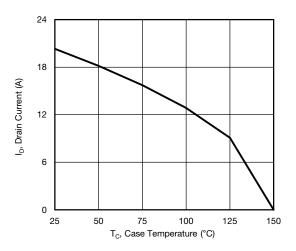


Fig. 10 - Maximum Drain Current vs. Case Temperature

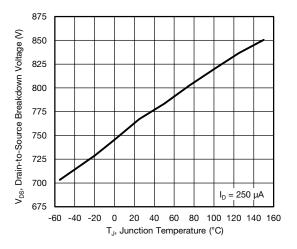
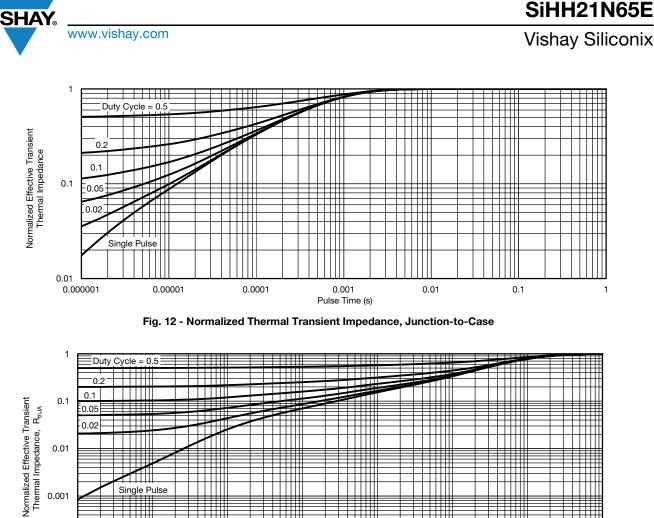


Fig. 11 - Temperature vs. Drain-to-Source Voltage

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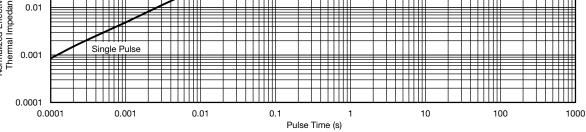


Fig. 13 - Normalized Thermal Transient Impedance, Junction-to-Ambient

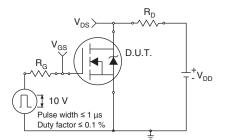


Fig. 14 - Switching Time Test Circuit

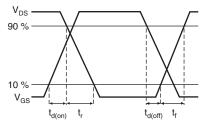


Fig. 15 - Switching Time Waveforms

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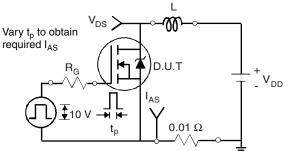
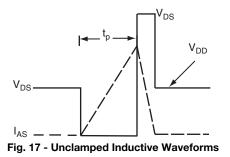


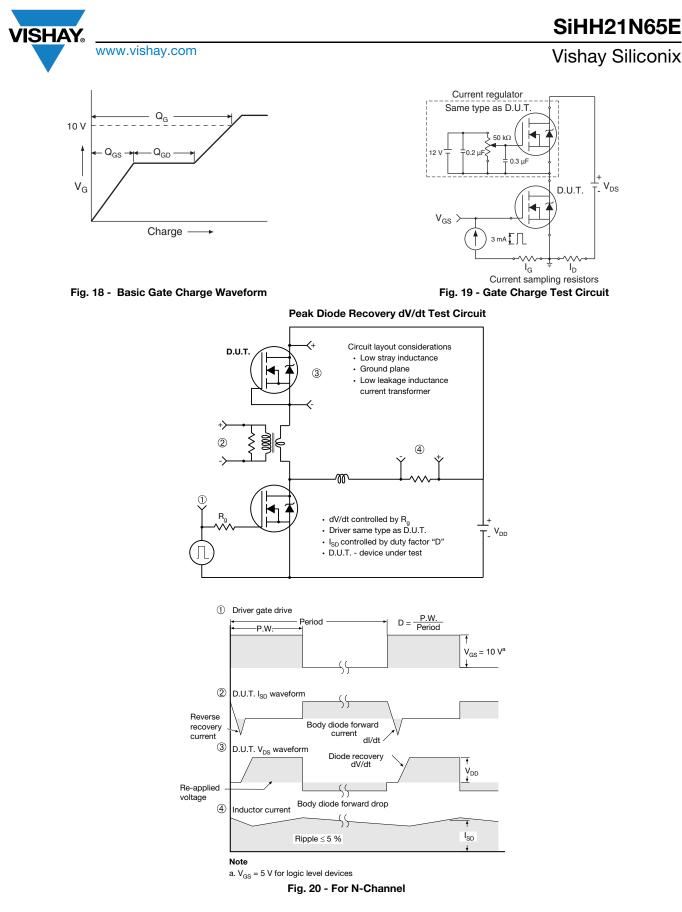
Fig. 16 - Unclamped Inductive Test Circuit



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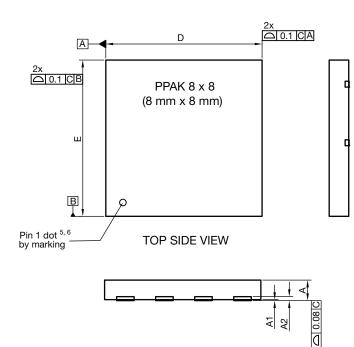


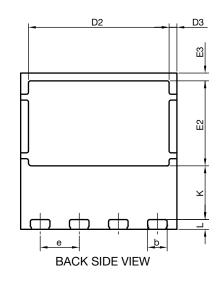
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PowerPAK[®] 8 x 8 Case Outline





DIM		MILLIMETERS			INCHES		
DIM.	MIN.	NOM.	MAX.	MIN.	NOM.	MAX.	
А	0.95	1.00	1.05	0.037	0.039	0.041	
A1	0.00	-	0.05	0.000	-	0.002	
A2		020 ref.					
b	0.95	1.00	1.05	0.037	0.039	0.041	
D	7.90	8.00	8.10	0.311	0.315	0.319	
D2	7.10	7.20	7.30	0.280	0.283	0.287	
D3		0.40 BSC		0.016 BSC			
е		2.00 BSC		0.079 BSC			
E	7.90	8.00	8.10	0.311	0.315	0.319	
E2	4.30	4.35	4.40	0.169	0.171	0.173	
E3		0.40 BSC		0.016 BSC			
К	2.75 BSC		0.108 BSC				
L	0.45	0.50	0.55	0.018	0.020	0.022	
N ⁽³⁾	8			8			

Notes

⁽¹⁾ Use millimeters as the primary measurement

⁽²⁾ Dimensioning and tolerances conform to ASME Y14.5 M - 1994

⁽³⁾ N is the number of terminals

⁽⁴⁾ The pin 1 identifier must be existed on the top surface of the package by using indentation mark or other feature of package body

⁽⁵⁾ Exact shape and size of this feature is optional

ECN: E20-0518-Rev. B, 28-Sep-2020 DWG: 6041

Revision: 28-Sep-2020

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Recommended Minimum PADs for PowerPAK[®] 8 mm x 8 mm



Dimensions in millimeters

Document Number: 68441



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